

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	154762	eddy adj current (electromagnet\$4 em e-m magnet\$4) adj flux	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:10
L2	156968	eddy adj current (electromagnet\$4 em e-m magnet\$4 electr\$4) adj flux	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:10
L3	4969032	coil inductor heat\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:11
L4	3953467	die chip ic integrated adj circuit package dice wafer substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:12
L5	2807796	ball adj grid solder interconnect\$4 via adj hole through adj hole connctet\$4 bond\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:15
L6	503	2 same 3 same 4 same 5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:16
L7	334	2 same 3 with 4 same 5	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:17
L8	304	7 and (@ad < "20031229")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/14 16:17
L9	2143	((438/107) or (438/109) or (438/456)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/14 16:19